







The WEBS-21D0 builds on Intel® Apollo Lake SoC and takes advantage of Intel Atom® Dual/Quad-Core™ E3900 Series processor technologies, especially its vastly superior Quad-Core[™] processing power and capability. The costeffective CPU with high performance and low power consumption is of great use to build up a compact system, WEBS-21D0. It supports a wide temperature from -25°C to 60°C for fan-less applications in harsh environment, such as POS, kiosk, digital signage, transportation and automation.

FEATURES

- Small and Exquisite fan-less design
- One 204-pin SO-DIMM supports DDR3L up to 8GB
- Intel® Apollo Lake SoC Platform
- 1x 2.5" SATA HDD/SSD, 1x mSATA, 1x Micro SD
- 1x M.2 socket (type E)
- 1x Antenna hole for wireless module support
- OP Vibration: 5Grms/10~500Hz
- OP Shock: 50G, 11msec
- IP40 Rating

System	
M/B (Board Dimension)	NANO-6062
System Chipset	Intel® Apollo Lake SoC
CPU	Intel® Atom® Dual/Quad Core E3900 series Processor (up to 12W) with 2MB Cache
BIOS	AMI uEFI BIOS
Memory	One DDR3L 1866/1600 SO-DIMM up to 8GB
Storage	1x 2.5" SATA HDD/SSD, 1x mSATA, 1x Micro SD
Watchdog Timer	Programmable by embedded controller
Expansion	- One M.2 socket (Type E) - One full size Mini-PCle socket (colay with mSATA)

External I/O		
Serial Port	1x RS-232/422/485 (selectable by BIOS)	
Display	1x VGA, 1x DP	
USB	2x USB 3.0	
Audio	Line-out (ALC892)	
Ethernet	2x Gigabit Ethernet (Intel® I210IT)	
Other	1x Antenna hole for wireless module	

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Power Input DC 12~24V

	Operation Temperature	-20ºC~60ºC
Storage Temperature		-40ºC~85ºC
	Relative Humidity	95%@40°C, non-condensing
	Operation Vibration	5Grms/10~500Hz, IEC 60068-2-6
	Operation Shock	50G, 11msec, IEC 60068-2-27

Di	mension	150 (W) x 150 (W) x 60 (H) mm
W	eight eight	1.3Kg
M	ounting	Wall, Panel/VESA® and DIN RAIL mounting

























